Lab. 01

Logic Design Lab. Spring 2023

Prof. ChangGun Lee

(cglee@snu.ac.kr)

TA. Seonghyeon Park

TA. Jihwan Kim

TA. Hoyong Lee

(rubis.ld.ta@gmail.com)

- Report/Assignment
 - Weekly Task (can be written in Korean or English)
 - Your report should include:
 - Lab Result (Must include pictures)
 - Disscussion (Concepts you learnen during the lab session, any errors you made, how to correct your errors, etc.)
 - Should be a single PDF file and less than 30MB
 - Should be submitted by email following the rules in the next slide
 - Deadline: Before the start of the next class (before 7:00pm)
 - Late Policy: +24h: -20% +48h: -50% +72h: -100%

Attendance

Arrive before the lecture is done: No penalty

– After the lecture: -10%

- Absent: -100%

- Rules for submitting reports / assignments
 - Submission: <u>rubis.ld.ta@gmail.com</u>
 - Email Title:
 - LDLAB_YYMMDD_class#_team#_NAME_StudentID
 - Report File Name:
 - LDLAB_YYMMDD_team#_NAME_StudentID.pdf

(*YYMMDD: LAB CLASS DATE. Not the submission date.)

EX)

email title : LDLAB_200409_001_team1_John Smith_2019-88888

report file name : LDLAB_200409_001_team1_John Smith_2019-88888.pdf

Points will be deducted if you submit word .doc file!

Cheating

- Zero tolerance
- You will receive an 'F'

Laboratory Manners

- Save materials don't be wasteful
- Put all tools and materials back to their proper place
- Clean up your desk and shut down the PC

"3 Strikes, 1 Out" Rule

- Three Warnings → -20% of entire lab grade
- Examples of strike:
 - Dirty desk or dirty personal lab cabinet
 - Intolerable attitude

Contents

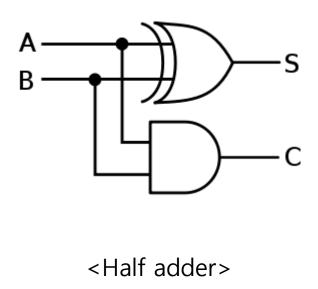
What you will learn:

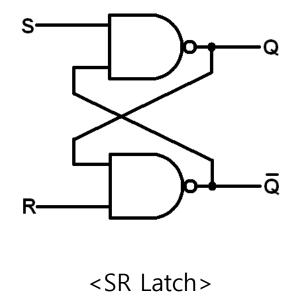
- Combinational / Sequential logic circuit
- Soldering / Prototyping
- Schematic Design
- Hardware Description Language (Verilog)
- Hardware Simulation
- Field-programmable Gate Array (FPGA) Programming

Final Project

Practice Guideline

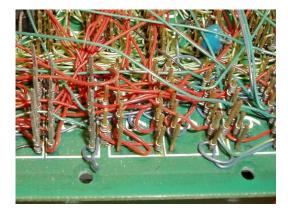
Combinational and sequential logic circuit



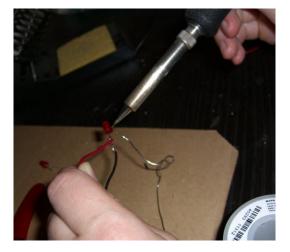


Soldering and prototyping

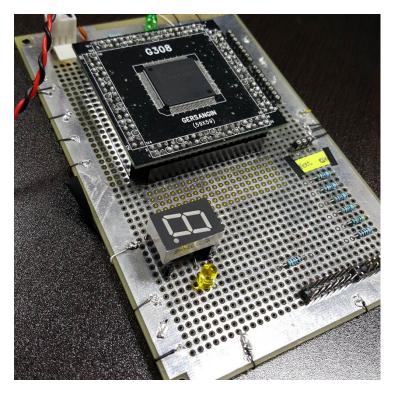
Wire wrapping







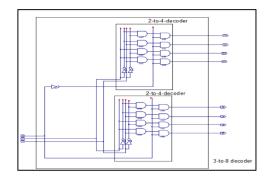




Prototyping

Computer Aided Design

Schematic Design



Hardware Description Language

```
module seq_test_module(data, clk, reset, q);
  input data, clk, reset;
  output q;
  reg q;

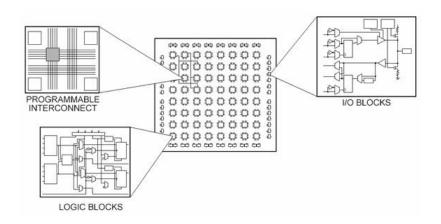
always @ (posedge clk)
  begin
    if (reset == 1)
        q <= 0;
    else
        q <= data;
  end
endmodule</pre>
```





Hardware Simulation

Field Programmable Gate Array (FPGA) Programming

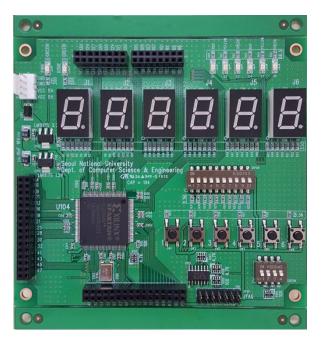




Final Project

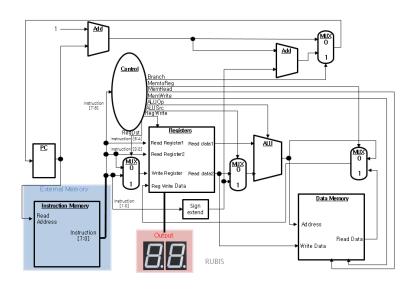
Final Project

You will be given:



<Custom-made logic design board>

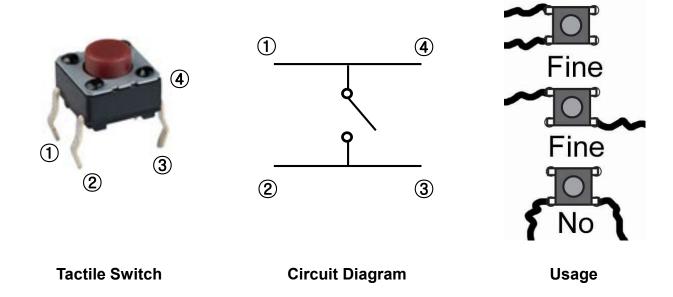
You will have to make:



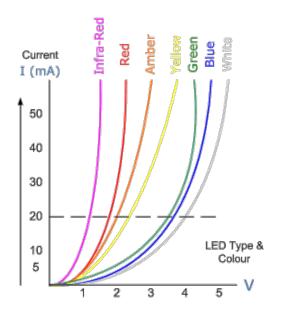
<Microprocessor>

Practice Guideline

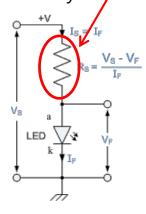
Tactile switches



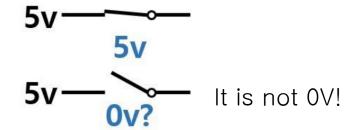




- LEDs emit colored light when passed through by forward current
- To protect LED from excessive current flow, using an appropriate resistor(around 3~400Ω) is necessary

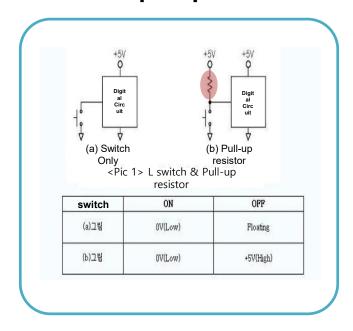


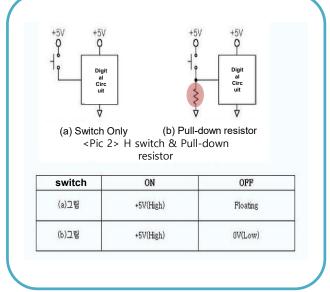
Floating



Noise Sensitive

Pull-up & pull-down resistors





Pull-up Resistor

Pull-down Resistor

Pull-up & pull-down resistors Switch on (b) Pull-up resistor (a) Switch Only (a) Switch Only (b) Pull-down resistor <Pic 1> L switch & Pull-up <Pic 2> H switch & Pull-down resistor resistor ON OFF switch ON switch (a)그림 OV(Low) Floating (a)그림 +5V(High) (b)그림 +5V(High) (b)그림

Pull-up Resistor

Pull-down Resistor

25 **RUBIS**

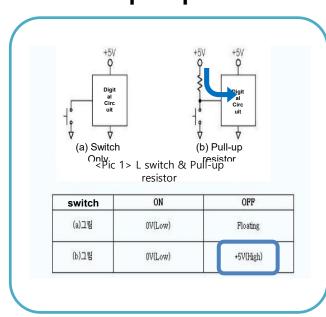
Switch off

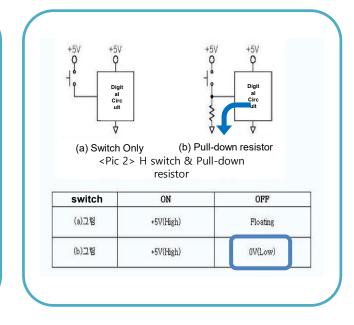
OFF

Floating

0V(Low)

Pull-up & pull-down resistors





Switch on

Switch off

Pull-up Resistor

Pull-down Resistor

Instruments

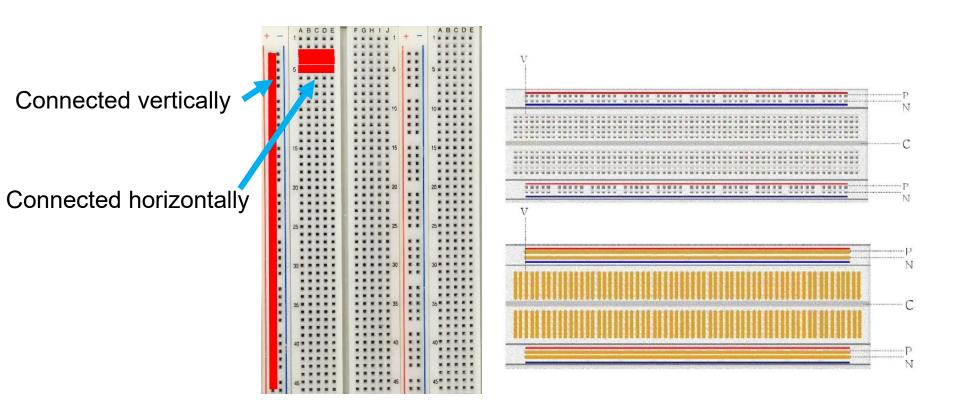


oscilloscope

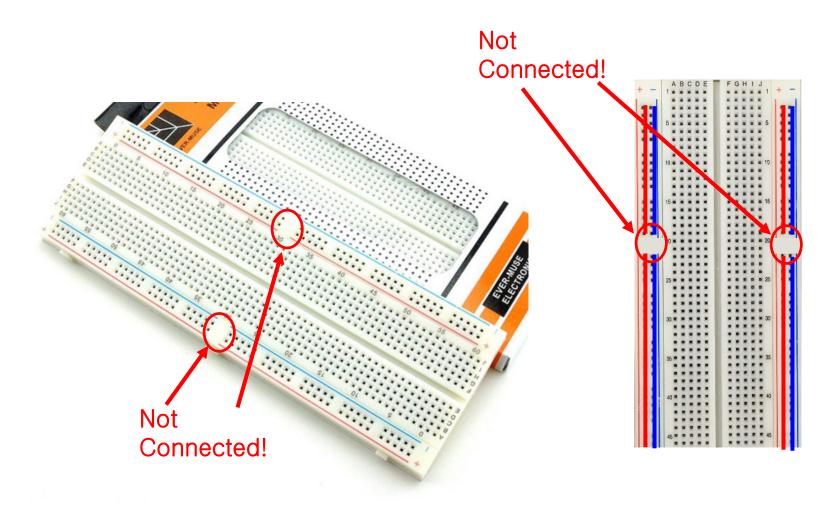


Function Generator Multimeter Power Supply

Breadboard

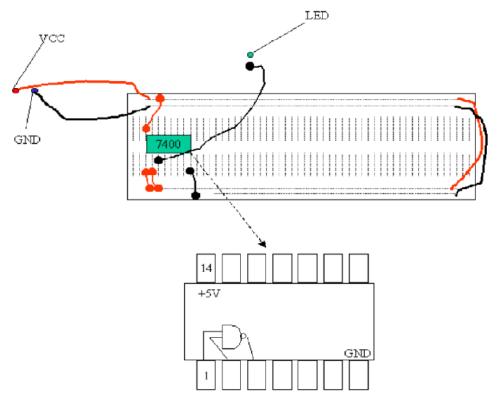


Breadboard(Separated)



Breadboard

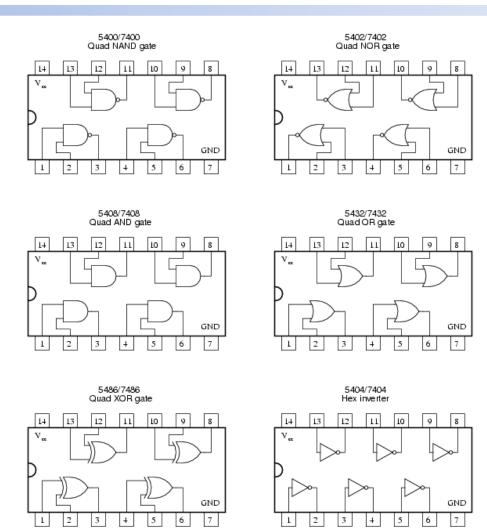
Implementation guide



✓ A circuit using 7400 Quad 2-Input NAND gate is constructed on the bread board

Logic Gates

Logic Gates



Tools – Solder, Soldering iron, Tip, etc



Soldering iron



Tin wire

Solder

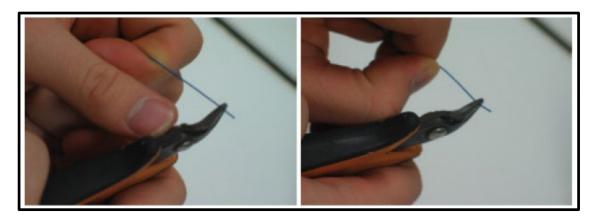
Wire



Nipper Bead nipper Desolder Chip extractor Long-nose plier

Tools

Bead Nipper



Ripping off coating

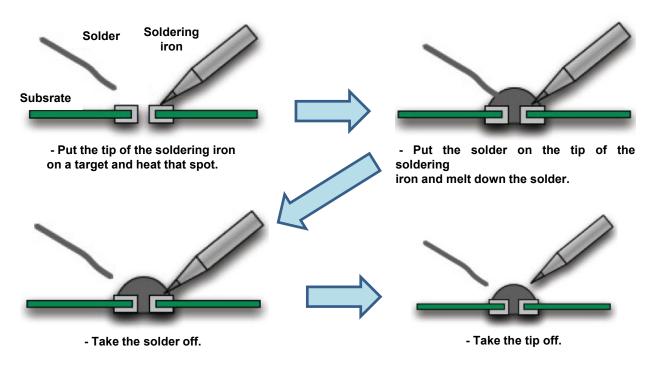
Extracting chips

- To extract IC chips, use IC Chip extractor.
- Never extract chips using your hand



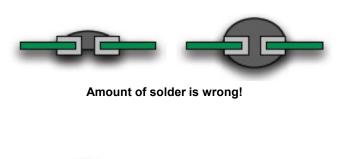
Soldering

Procedure



Soldering

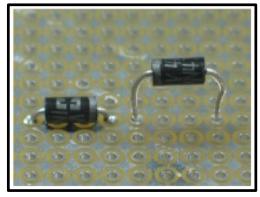
Wrong cases





Taking a tip off is too late!

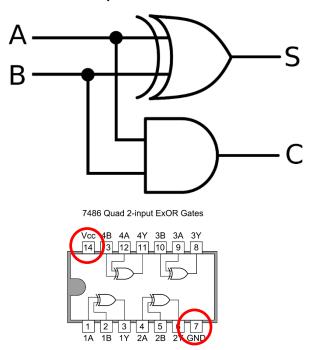
Temperature of the soldering iron is not high enough!



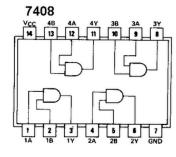
Components must be pressing against the board.

Lab

Let's implement half-adder on breadboard.



Input		Output	
Α	В	Sum	Carry
0	0	0	0
0	1	1	0
1	0	1	0
1	1	0	1



All homework do with your team.

Submit a report per person.

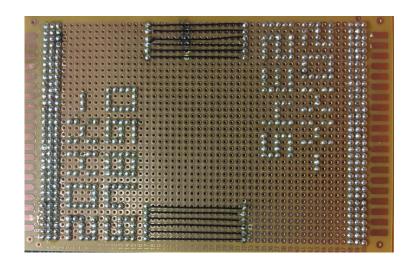
1. Half-adder

- Disscussion (Concepts you learnen during the lab session, any errors you made, how to correct your errors, etc.)
- Result for every case in truth table (pictures)

2. Soldering

Practice soldering and wiring as the figure below. (Soldering 3 lines and student ID, and 6 slim wires for each person)

One of you should use another board.



- Write a report
 - Either in Korean or in English
 - Must include the result and discussion of the practice
 - # of pages doesn't matter
 - Documents should be submitted as PDF file.
 - All the files should be compressed to ZIP format (if there are several files)
 - Due:

```
Class 001 – April, 10th (Before class begin at 7:00pm)
```

Class 002 - April, 11th (Before class begin at 7:00pm)

Class 003 - April, 13th (Before class begin at 7:00pm)